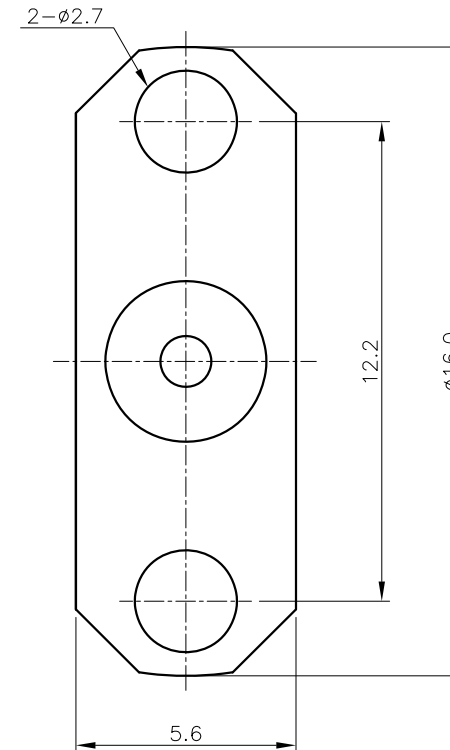
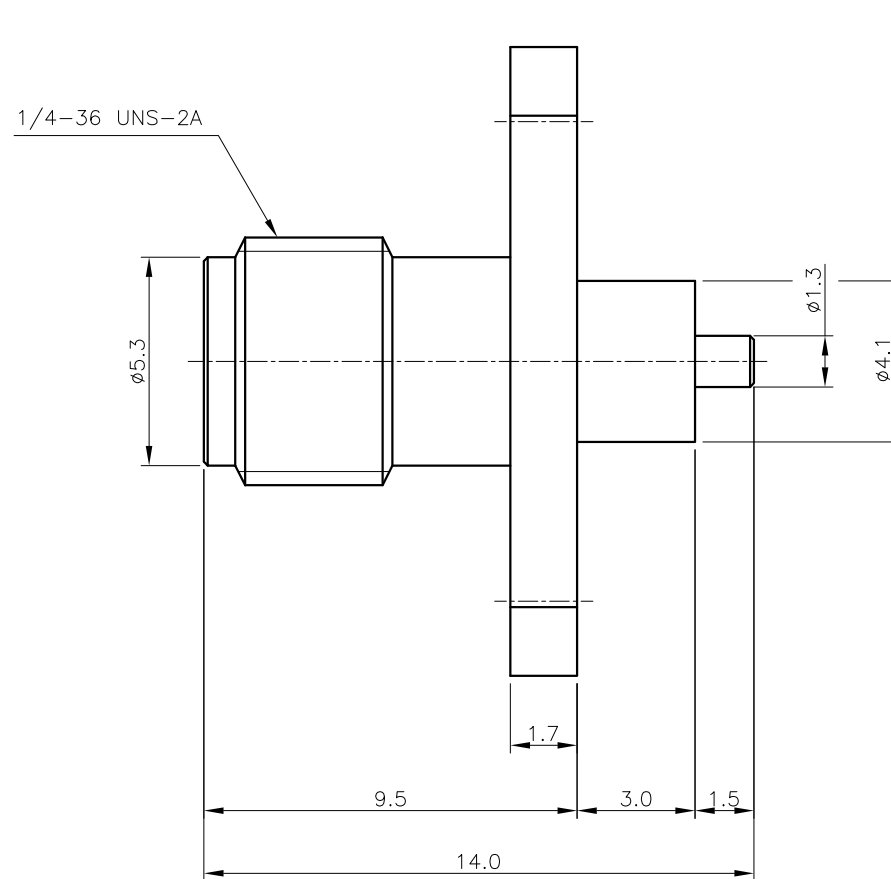


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1	Initial Registration	E.H.KIM	I.C.KIM	2014. 08. 27.



3	INSULATOR	1	TEFLON		DIN00190-N/1 (HA181B)
2	CONTACT	1	BeCu	Gold Plate	DCT00225-5/1 (E2360)
1	BODY	1	MBsBD	Gold Plate	DBD00347-5/1 (D2036)
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2014. 08. 27.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY I.C.KIM			
MATERIAL -		CHECKED BY -	TITLE SMA50 SOLDER END J-2H		
		DRAWN BY E.H.KIM			
FINISH -		SCALE 5/1	UNIT mm	 A4	DWG NO. CN03273-7/1
					REVISION I R